Power MOSFET

-8.0 V, -1.4 A, Single P-Channel, SC-70

Features

- Leading Trench Technology for Low R_{DS(on)} Extending Battery Life
- -1.8 V Rated for Low Voltage Gate Drive
- SC-70 Surface Mount for Small Footprint (2 x 2 mm)
- Pb–Free Package is Available

Applications

- High Side Load Switch
- Charging Circuit
- Single Cell Battery Applications such as Cell Phones, Digital Cameras, PDAs, etc.

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parame	ter		Symbol	Value	Units		
Drain-to-Source Voltage	V _{DSS}	-8.0	V				
Gate-to-Source Voltage			V _{GS}	±8.0	V		
Continuous Drain	Steady $T_A = 25^{\circ}C$		۱ _D	-1.4	А		
Current (Note 1)	State T _A = 70°C			-1.1			
	$t \le 5 \text{ s}$ $T_A = 25^{\circ}C$			-1.5	А		
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	P _D	0.29	W		
	t ≤ 5 s			0.33	W		
Pulsed Drain Current	tp =	= 10 μs	I _{DM}	-3.0	А		
Operating Junction and S	torage Te	mperature	T _J , T _{STG}	–55 to 150	°C		
Source Current (Body Diode), Continuous			۱ _S	-0.46	А		
Lead Temperature for Sol (1/8" from case for 10		rposes	ΤL	260	°C		

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Units
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	430	°C/W
Junction–to–Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	375	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

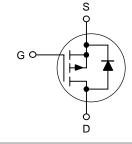


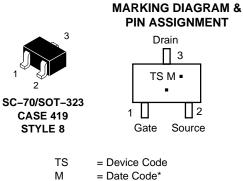
ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Тур	I _D Max
	65 mΩ @ –4.5 V	
-8.0 V	78 mΩ @ –2.5 V	–1.4 A
	117 mΩ @ –1.8 V	







⁼ Pb-Free Package

(Note: Microdot may be in either location) *Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTS2101PT1	SOT-323	3000/Tape & Reel
NTS2101PT1G	SOT-323 (Pb-Free)	3000/Tape & Reel

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise stated) Γ

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = -250 μ A		-8.0	-20		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				-10		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -6.4 V	$T_J = 25^{\circ}C$			-1.0	μΑ
		$V_{DS} = -6.4 V$	$T_J = 70^{\circ}C$			-5.0	1
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8.0 V$				±100	nA

ON CHARACTERISTICS (Note 2)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = -250 \ \mu A$	-0.45	-0.7		V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J			2.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -1.0 \text{ A}$		65	100	mΩ
		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$		78	140	
		$V_{GS} = -1.8$ V, $I_D = -0.3$ A		117	210	

CHARGES AND CAPACITANCES

Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = -8.0 V	640	pF
Output Capacitance	C _{OSS}	$v_{\rm DS} = -8.0 \ v$	120	
Reverse Transfer Capacitance	C _{RSS}		82	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5.0 \text{ V}, V_{DD} = -5.0 \text{ V},$ $I_{D} = -1.0 \text{ A}$	6.4	nC
Threshold Gate Charge	Q _{G(TH)}	$I_{\rm D} = -1.0 \rm A$	0.7	
Gate-to-Source Charge	Q _{GS}		1.0	
Gate-to-Drain Charge	Q _{GD}	1	1.5	

SWITCHING CHARACTERISTICS (Note 3)

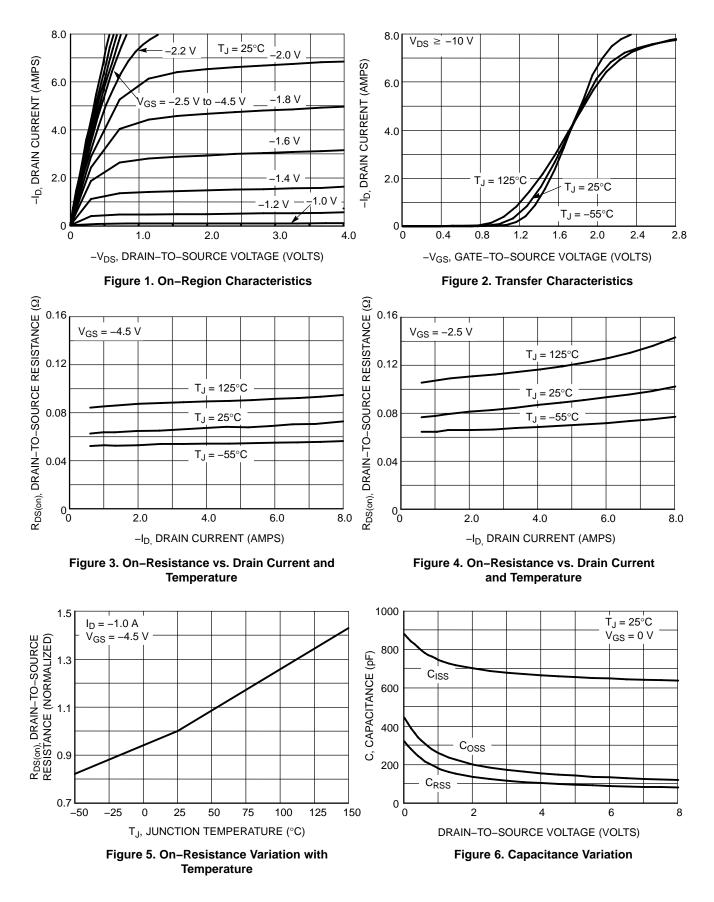
Turn–On Delay Time	t _{d(ON)}	$V_{GS} = -4.5 \text{ V}, V_{DD} = -4.0 \text{ V},$ $I_D = -1.0 \text{ A}, \text{ R}_G = 6.2 \Omega$	6.2	ns
Rise Time	tr	$I_{\rm D} = -1.0$ A, $R_{\rm G} = 0.2$ S2	15	
Turn-Off Delay Time	t _{d(OFF)}		26	
Fall Time	t _f		18	

DRAIN-SOURCE DIODE CHARACTERISTICS

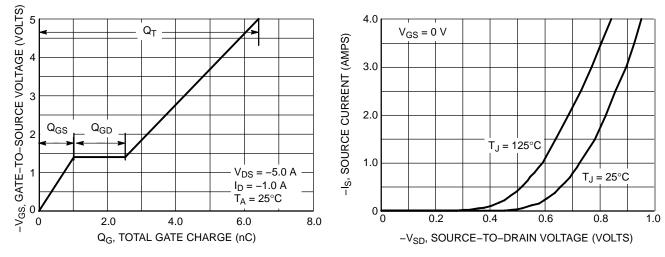
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = -0.3 A	$T_J = 25^{\circ}C$	-0.62	-1.2	V
		$I_{S} = -0.3 A$	T _J = 125°C	-0.51		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 V, dI_{SD}/d$ $I_{S} = -1.$	t = 100 A/μs,	23.4		ns
Charge Time	Ta	I _S = –1.0 A		7.7		
Discharge Time	Tb			15.7		
Reverse Recovery Charge	Q _{RR}			9.5		nC

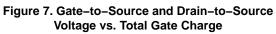
Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

TYPICAL ELECTRICAL CHARACTERISTICS



TYPICAL ELECTRICAL CHARACTERISTICS

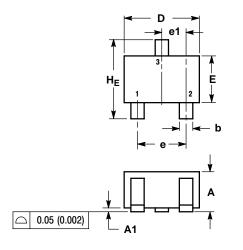


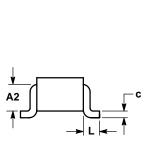




PACKAGE DIMENSIONS

SC-70 (SOT-323) CASE 419-04 ISSUE M





NOTES DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982 2

CONTROLLING DIMENSION: INCH.

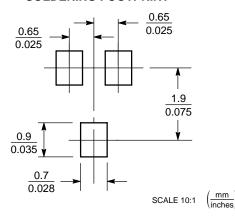
STYLE 8 PIN 1. GATE

2. SOURCE

DRAIN

	MILLIMETERS				INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.90	1.00	0.032	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2		0.7 REF		0.028 REF			
b	0.30	0.35	0.40	0.012	0.014	0.016	
С	0.10	0.18	0.25	0.004	0.007	0.010	
D	1.80	2.10	2.20	0.071	0.083	0.087	
E	1.15	1.24	1.35	0.045	0.049	0.053	
е	1.20	1.30	1.40	0.047	0.051	0.055	
e1	0.65 BSC			0.026 BSC			
L		0.425 REF			0.017 REF		
HE	2.00	2.10	2.40	0.079	0.083	0.095	

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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